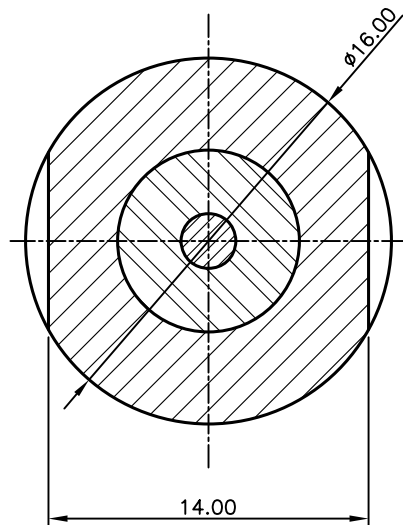


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2020. 08. 18.

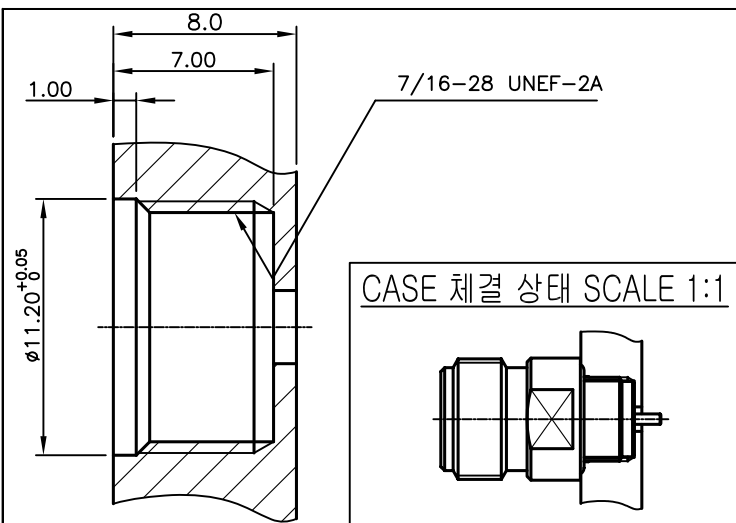
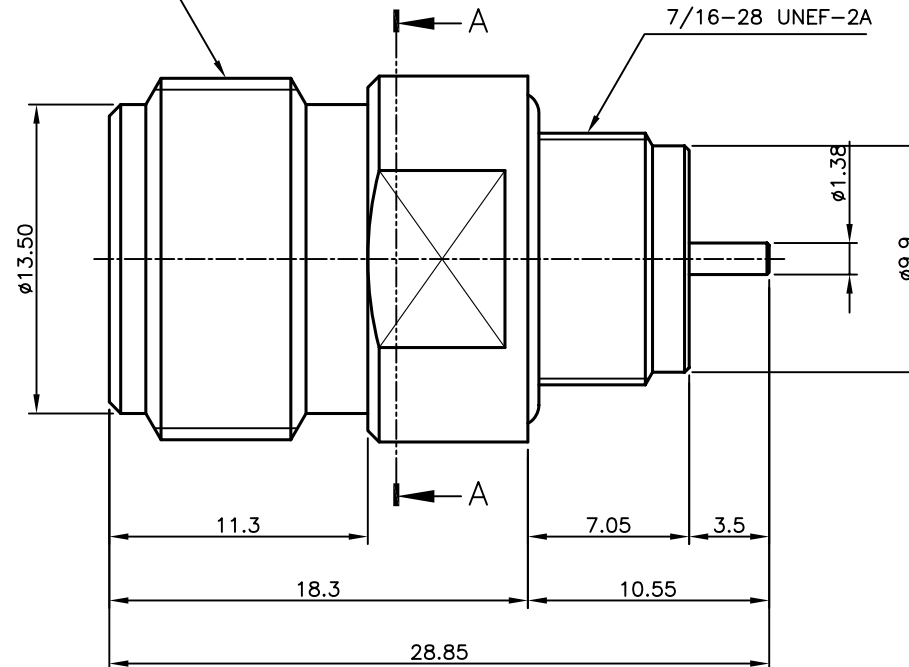


CASE 체결 치수

SECTION A-A

5/8-24 UNEF-2A

7/16-28 UNEF-2A



CASE 체결 상태 SCALE 1:1

4	INSULATOR	1	TEFLON	White	DIN00670-N/2
3	GASKET	1	SILICONE RUB	RED	DGK00098-N/1
2	CONTACT	1	BeCu C17300	Silver Plate (3μm)	DCT00713-5/4
1	BODY	1	MBsBD C3604BD-F	binary alloy (SUICO)	DBD03410-5/4
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 08. 18.	
	Angle	APPROVED BY	
MATERIAL	±0.3	CHECKED BY	
	±1°	DRAWN BY I.C.KIM	
FINISH	-	SCALE 3/1	
	-	UNIT mm	



RF & MICROWAVE
TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE
N50 SOLDER END JB (F/F)

DWG NO. CN03048-7/6

REVISION I R SHEET 1 of 1